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APPLICATION NO.	F	ILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/673,049	10/673,049 09/26/2003		Kameshwar Poolla	AWS-033	8058
25199	7590	02/22/2005		EXAMINER	
LARRY WILLIAMS 3645 MONTGOMERY DR SANTA ROSA, CA 95405-5212				CABRERA	, ZOILA E
				ART UNIT	PAPER NUMBER
				2125	
				DATE MAILED: 02/22/2005	;

Please find below and/or attached an Office communication concerning this application or proceeding.

		Applic	ation No.	Applicant(s)				
		10/673	3,049	POOLLA ET AL.	POOLLA ET AL.			
	Office Action Summary	Exami	ner	Art Unit				
		Zoila E	. Cabrera	2125				
Period fo	The MAILING DATE of this commun	nication appears on	the cover sheet	with the correspondence a	ddress			
A SH THE - Exte after - If the - If NO - Failu Any earn	CORTENED STATUTORY PERIOD F MAILING DATE OF THIS COMMUN Insions of time may be available under the provision. SIX (6) MONTHS from the mailing date of this come period for reply specified above is less than thirty (c) Deriod for reply is specified above, the maximum so ure to reply within the set or extended period for reply reply received by the Office later than three months ed patent term adjustment. See 37 CFR 1.704(b).	IICATION. s of 37 CFR 1.136(a). In no munication. 30) days, a reply within the tatutory period will apply ar y will. by statute, cause the	statutory minimum of to will expire SIX (6) Mapplication to become	a reply be timely filed thirty (30) days will be considered time ONTHS from the mailing date of this ABANDONED (35 U.S.C. § 133).				
Status	•		•					
1)⊠	Responsive to communication(s) file	ed on <u>26 Septemb</u> e	<u>er 2003</u> .					
2a) <u></u> □	This action is FINAL .	2b)⊠ This action i	s non-final.					
3)□	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.							
Disposit	ion of Claims							
4)⊠ 5)⊠ 6)⊠ 7)⊠	Claim(s) <u>1-21</u> is/are pending in the 4a) Of the above claim(s) is/a Claim(s) <u>15-17</u> is/are allowed. Claim(s) <u>1-9 and 11-14</u> is/are reject Claim(s) <u>10, 18-21</u> is/are objected to Claim(s) are subject to restri	are withdrawn from red. o.						
Applicat	ion Papers							
9)[7]	The specification is objected to by the	ne Examiner.						
	The drawing(s) filed on is/are		b) objected t	to by the Examiner.				
	Applicant may not request that any obje			•				
	Replacement drawing sheet(s) including	g the correction is rec	quired if the drawi	ng(s) is objected to. See 37 C	FR 1.121(d).			
11)	The oath or declaration is objected t	o by the Examiner.	Note the attach	ed Office Action or form P	TO-152.			
Priority (under 35 U.S.C. § 119							
12)□ a)	Acknowledgment is made of a claim All b) Some * c) None of: 1. Certified copies of the priority 2. Certified copies of the priority 3. Copies of the certified copies application from the Internation	documents have be documents have be of the priority documental Bureau (PCT F	peen received. peen received in Iments have bee Rule 17.2(a)).	Application No en received in this Nationa	l Stage			
Attachmen	ıt(s)							
1) 🛛 Notic	ce of References Cited (PTO-892)			w Summary (PTO-413)				
3) 🔲 Infon	ce of Draftsperson's Patent Drawing Review (I mation Disclosure Statement(s) (PTO-1449 or er No(s)/Mail Date			lo(s)/Mail Date of Informal Patent Application (PT	O-152)			

DETAILED ACTION

Page 2

Oath/Declaration

1. The oath or declaration is defective. A new oath or declaration in compliance with 37 CFR 1.67(a) identifying this application by application number and filing date is required. See MPEP §§ 602.01 and 602.02.

The oath or declaration is defective because:

The filing date of Serial No. 60/469377 is incorrect, i.e., 08 <u>March</u> 2003. Please note that the filing date of the Provisional Application, 60/469,377 is 08 May 2003.

Appropriate correction is required.

Claim Objections

2. Claim 18 and therefore claims 19-21 are objected to because of the following informalities: Claim 18, line 1, recite an indefinite phrase "In a combination,". Please note that claims should clearly define either a system or method. Appropriate correction is required.

Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the

applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1-6, 12 and 14 are rejected under 35 U.S.C. 102(e) as being anticipated by **Bode et al. (US 6,535,774 B1)**.

Regarding claim 1, **Bode** discloses a method of adjusting a spatial and temporal profile of process conditions of a substrate during processing, the method being performed using a process apparatus and a controller, the controller and process apparatus being coupled so the controller is capable of controlling the spatial and temporal profile of process conditions experienced by the substrate, the controller being capable of using at least one control parameter (Figs. 1-3, and 5), the method comprising the steps of:

- i. constructing a perturbation model that relates changes in the control parameters to resulting changes in the spatial and temporal profile of process conditions experienced by the substrate (Col. 4, lines 47-52; Col. 3, lines 59-66; Col. 11, line 59 Col. 12, line 31; Fig. 5, step 530);
- ii. using the perturbation model with <u>at least one of</u> a performance objective and a constraint to derive optimized control parameters (Col. 3, lines 17-25; Col. 4, lines 5-30, i.e., constraint corresponds to temperature deviations from baseline or any other variable in the model); and
- iii. operating the controller with the optimized control parameters (Col. 4, lines 56-65; Fig. 1, step 140; Fig. 5, step 540).

As for claims 2-6 Bode discloses,

Application/Control Number: 10/673,049 Page 4

Art Unit: 2125

 the process comprises a process used for fabricating integrated circuits on semiconductor wafers (Col. 11, lines 49-56);

- the process is <u>selected from the group consisting of</u> photolithography, plasma etch, chemical vapor deposition, thermal anneal, ion implantation, post exposure bake, and physical vapor deposition (Col. 11, lines 49-50);
- the perturbation model comprises a linear model for small changes in the spatial and temporal profile of process conditions (Col. 12, lines 18-19);
- the perturbation model comprises a nonlinear model for large changes in the spatial and temporal profile of process conditions (Col. 12, lines 18-19);
- the optimized control parameters are derived using the performance objective and the constraint (Col. 4, lines 5-18, performance objective corresponds to magnification control, constraint corresponds to temperature).

Regarding claims 12 and 14, Bode discloses,

- the spatial and temporal profile comprises <u>at least one of</u> temperature, plasma potential, ion energy, ion density, and heat flux for the substrate in a glow discharge plasma process (Col. 4, lines 5-7);
- the substrate is <u>selected from the group consisting of</u> semiconductor wafer,
 flatpanel display, and photolithography mask (Col. 9, lines 22-23).

Claim Rejections - 35 USC § 103

4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

Art Unit: 2125

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 7-9 and 13 are rejected under 35 U.S.C. 103(a) as being unpatentable over **Bode et al. (US 6,535,774 B1)** in view of **Moslehi (US 5,635,409)**.

Bode discloses the limitations of claim 1 above but fail to specifically disclose the limitations of claims 7-9 and 13. However, **Moslehi** discloses such limitations as follows:

- the process includes a transient regime and a near steady-state regime and the optimized control parameters are derived in order to optimize <u>at least one of</u> the transient regime and the near steady-state regime (Col. 3, lines 65 Col. 4, lines 2; Col. 15, lines 43-48);
- the substrate sensitive process includes a transient regime and a near steadystate regime and the optimized control parameters are derived in order to optimize the transient regime (Col. 3, lines 65 – Col. 4, lines 2; Col. 15, lines 43-48);
- the process includes a transient period and a near steady-state regime and the optimized control parameters are derived in order to optimize the near steadystate regime (Col. 3, lines 65 – Col. 4, lines 2; Col. 15, lines 43-48);
- the spatial and temporal profile comprises temperature of the substrate in a glow discharge plasma process (Figs. 3, 4-5; Col. 8, lines 35-45).

Therefore, it would have been obvious to a person of the ordinary skill in the art at the time the invention was made to combine the teachings of **Bode** with the real-time

temperature controller of **Moslehi** because it would provide a real-time multipoint semiconductor wafer temperature and process uniformity control system for use with a semiconductor wafer fabrication during steady-state and transient wafer heating conditions (**Moslehi**, Col. 3, lines 40-48).

Page 6

5. Claim 11 is rejected under 35 U.S.C. 103(a) as being unpatentable over **Bode et** al. (US 6,535,774 B1).

Regarding claim 11, **Bode** discloses the limitations of claim 1 above and further discloses providing a predetermined performance objective and a constraint; calculating adjustments for the control parameters using the performance objective, the constraint, and the perturbation model (Fig. 5, steps 520 – 540; Col. 4, lines 56-65; Col. 12, lines 5-31); and d) adjusting the control parameters in the controller and using the adjustments so as to provide the optimized control parameters (Fig. 5, step 540). **Bode** does not specifically disclose measuring an initial conditions profile of time resolved and spatially resolved data. However, **Bode** discloses modifying control inputs (Abstract). Therefore, it would have been obvious to a person of the ordinary skill in the art at the time the invention was made to measure initial conditions profile of time resolved and spatially resolved data in order to correct any deviations of a desired output as taught by **Bode** (Col. 4, lines 56-65) because it would provide an optimum system or superior performance (Col. 12, lines 39-42).

Application/Control Number: 10/673,049 Page 7

Art Unit: 2125

Allowable Subject Matter

6. Claims 15-17 are allowed.

Claim 10 is objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Claims 18 and therefore claims 19-21 would be allowable if rewritten or amended to overcome the objection, set forth in this Office action.

The following is a statement of reasons for the indication of allowable subject matter: The allowability of the claims resides in part that the closest prior art of record **Bode et al. (US 6,535,774)** does not disclose, alone or in combination, the steps of:

Regarding claims 10, 15 and 18, acquiring data for a perturbation model for a number, N, of control parameters, N being at least 1, by performing a minimum of N temperature profile measurements, wherein each temperature profile results from perturbing one or more of the control parameters until each of the control parameters has been perturbed; constructing the perturbation model by aligning and synchronizing the temperature profile data so that the data share the same time scale to allow representing the perturbation model as T(x,y,t), in combination with the other elements and features of the claimed invention.

Conclusion

7. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Application/Control Number: 10/673,049 Page 8

Art Unit: 2125

Any inquiry concerning communication or earlier communication from the examiner should be directed to Zoila Cabrera, whose telephone number is (571) 272-3738. The examiner can normally be reached on M-F from 8:00 a.m. to 5:30 p.m. EST (every other Friday).

If attempts to reach the examiner by phone fail, the examiner's supervisor, Leo Picard, can be reached on (571) 272-3749. Additionally, the fax phones for Art Unit 2125 are (703) 872-9306. Any inquiry of a general nature or relating to the status of this application should be directed to the group receptionist at (703) 305-9600.

Zoila Cabrera Patent Examiner

2/18/05